

# **Bipolar Junction Transistors**

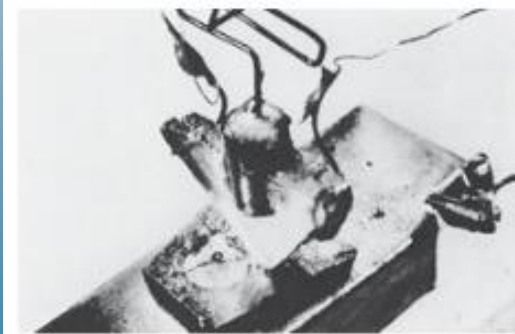
Topic 3 (Chapter 3)

# OBJECTIVES

- Basic construction and operation
- Biasing
- Characteristics of an npn or pnp transistor
- Important parameters that define the response of a transistor
- Testing a transistor and identify the three terminals

# TRANSISTOR INVENTION

- On December 23, 1947, Dr. S. William Shockley, Walter H. Brattain, and John Bardeen demonstrated the amplifying action of the first transistor at the Bell Telephone Laboratories
- The original transistor (a point-contact transistor)



**FIG. 3.2**

*The first transistor. (Courtesy of AT&T Archives and History Center.)*

Dr. William Shockley (seated); Dr. John Bardeen (left); Dr. Walter H. Brattain. (Courtesy of AT&T Archives and History Center.)

**Dr. Shockley** Born: London, England, 1910  
PhD Harvard, 1936

**Dr. Bardeen** Born: Madison, Wisconsin, 1908  
PhD Princeton, 1936

**Dr. Brattain** Born: Amoy, China, 1902  
PhD University of Minnesota, 1928

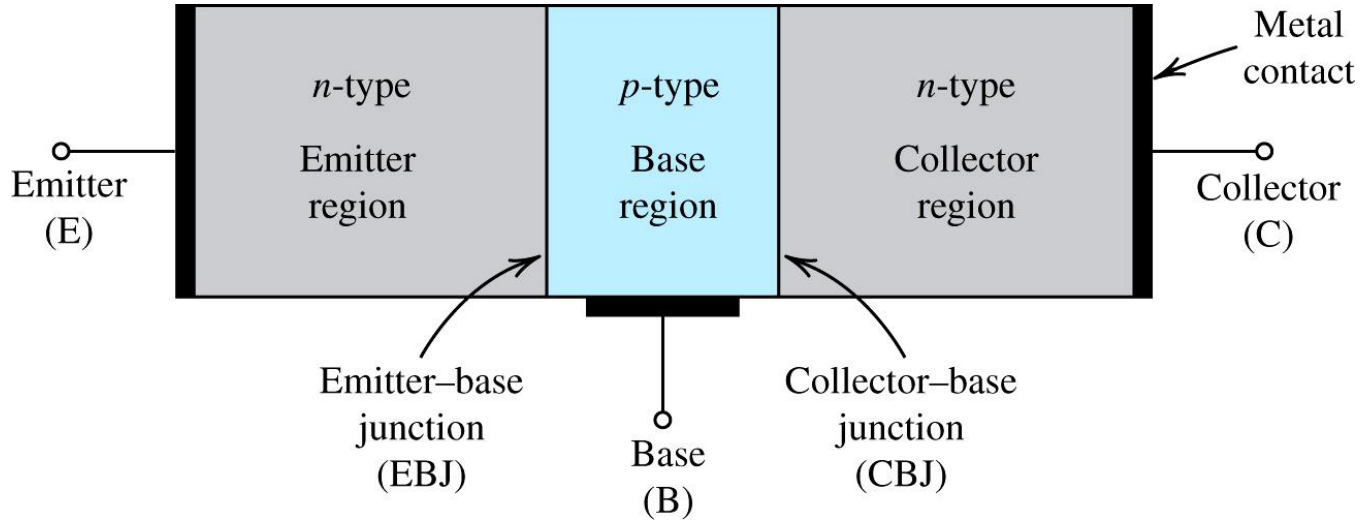
All shared the Nobel Prize in 1956 for this contribution.

# **Bipolar Junction Transistor (BJT)**

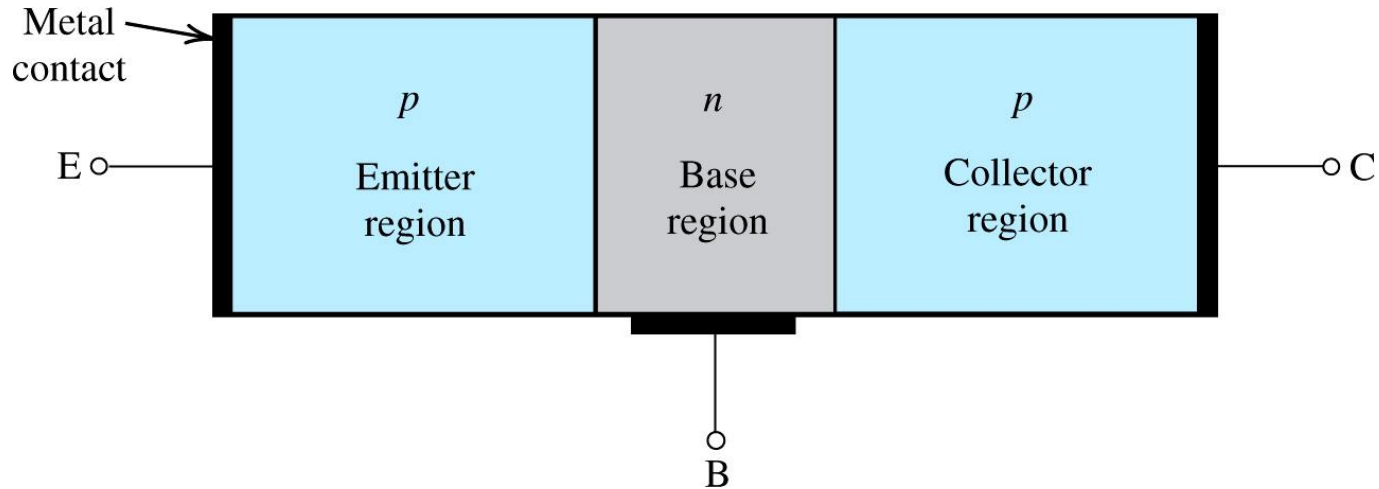
- **A semiconductor device that can amplify (enlarge) electronic signals such as radio and television signals**
- **The transistor has led to many other semiconductor inventions including the integrated circuit (IC)**
  - **Backbone of modern civilization**
- **Bipolar means “two polarities” - electrons and holes**

# BJT Device Structure

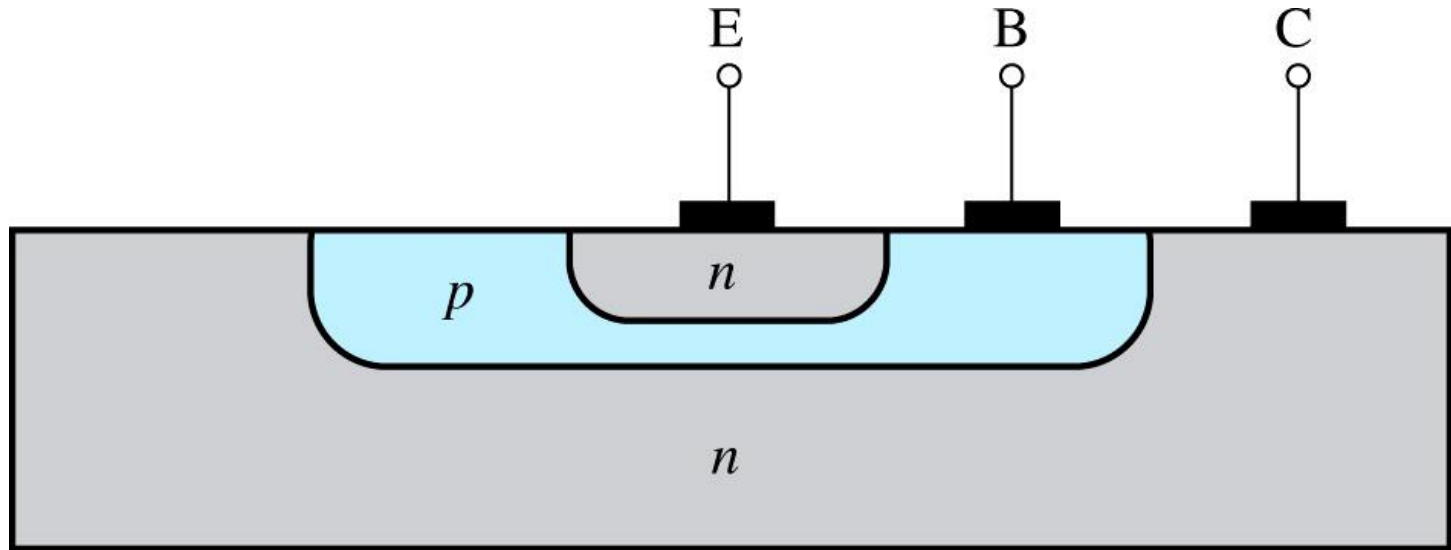
**NPN**



**PNP**



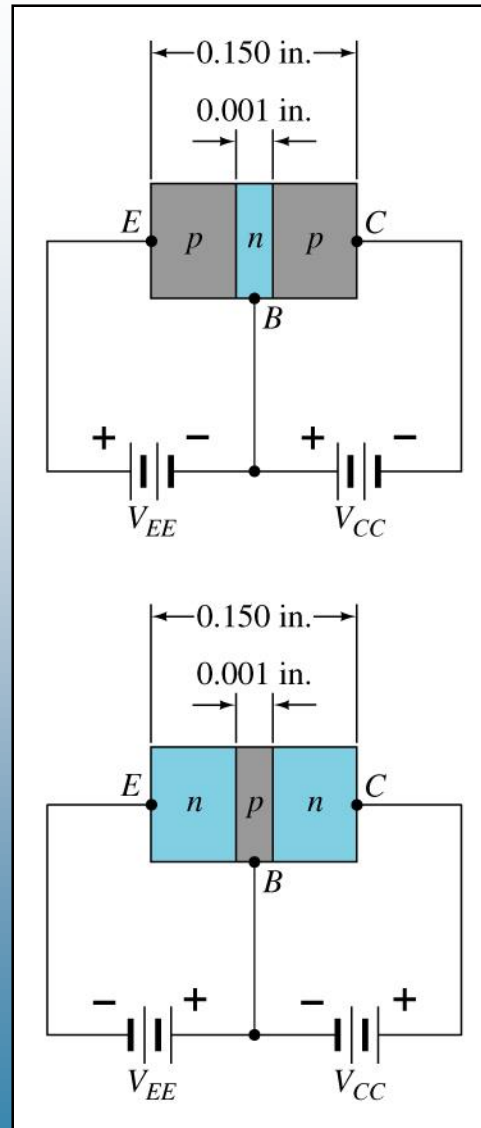
# The Structure of BJT Transistors in ICs



**Figure:** A more realistic (but still simplified) cross section of an *npn* BJT

- The collector virtually surrounds the emitter region
- The device is *not* symmetrical, and thus the emitter and collector cannot be interchanged.

# Discrete Component BJT Construction



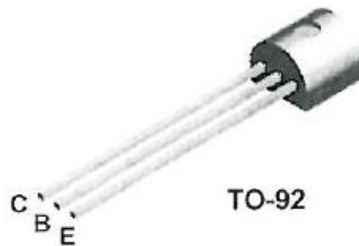
*pnp*

*npn*

# Transistor pictures from a datasheet..

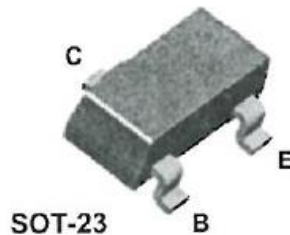
**FAIRCHILD**  
SEMICONDUCTOR™

**2N3904**



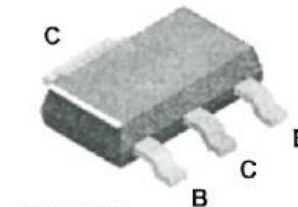
TO-92

**MMBT3904**



SOT-23  
Mark: 1A

**PZT3904**



SOT-223

## **NPN General Purpose Amplifier**

This device is designed as a general purpose amplifier and switch. The useful dynamic range extends to 100 mA as a switch and to 100 MHz as an amplifier.

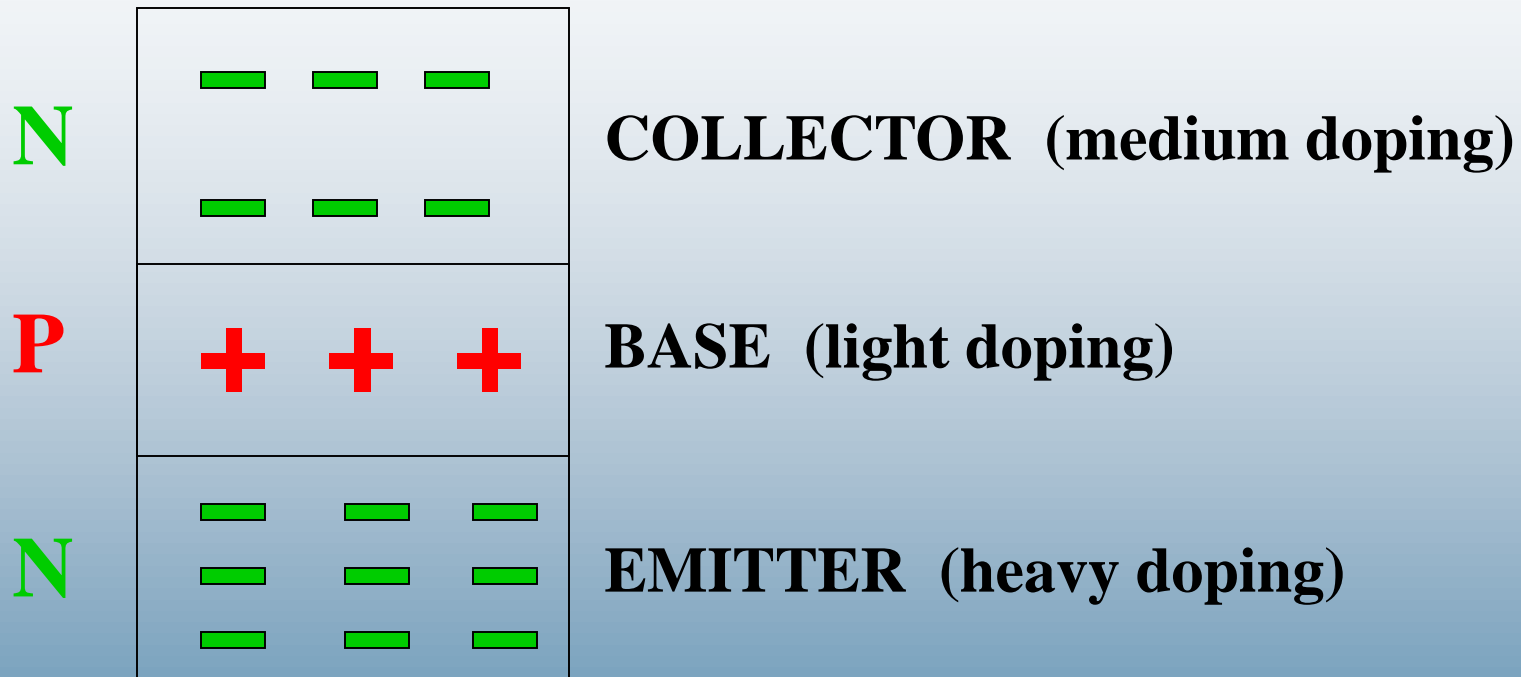
2N3904 / MMBT3904 / PZT3904



# Unbiased transistor

- Three doped regions: emitter, base, and collector
- Two pn junctions: emitter-base and base-collector
  - Like two back-to-back connected diodes
- NPN or PNP
- Silicon or germanium

**The bipolar junction transistor has 3 doped regions.**



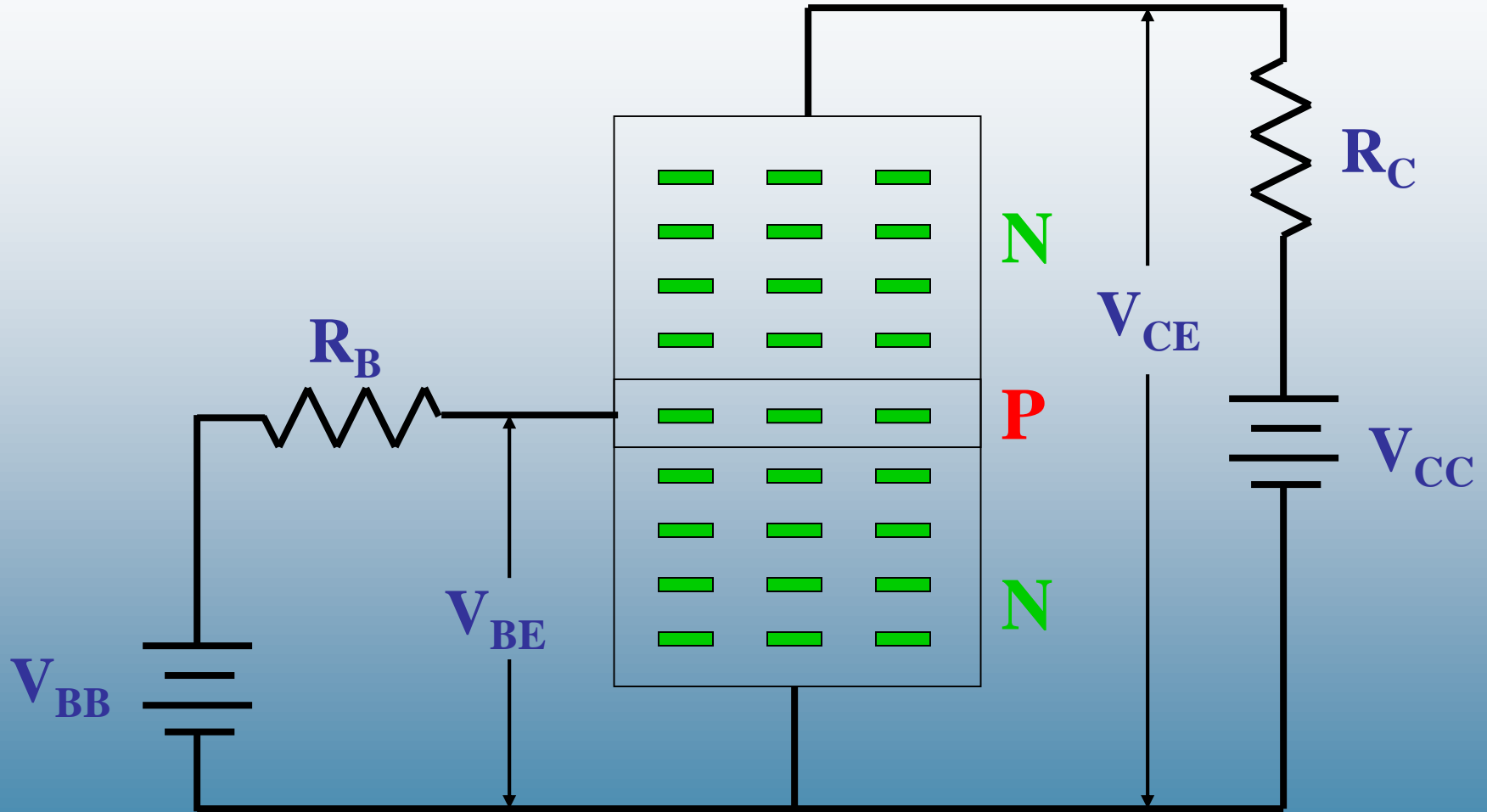
# Unbiased Transistor



# Biased transistor

- Forward bias the **emitter** diode
- Reverse bias the **collector** diode

In a properly biased NPN transistor, the emitter electrons diffuse into the base and then go on to the collector.



# Purposes of Different Transistor Regions

- The heavily doped emitter emits or injects its free electrons into the base
- The lightly doped base also has a well-defined purpose: to pass emitter-injected electrons on to the collector
- The collector is so named because it collects or gathers most of the electrons from the base

# Electron Movement

- If  $V_{BE}$  is greater than the emitter-base barrier potential (0.7 V for Si), emitter electrons will enter the base region
- These electrons can flow in either of two directions.
  1. They can flow out of the base through the base terminal
  2. They can flow into the collector

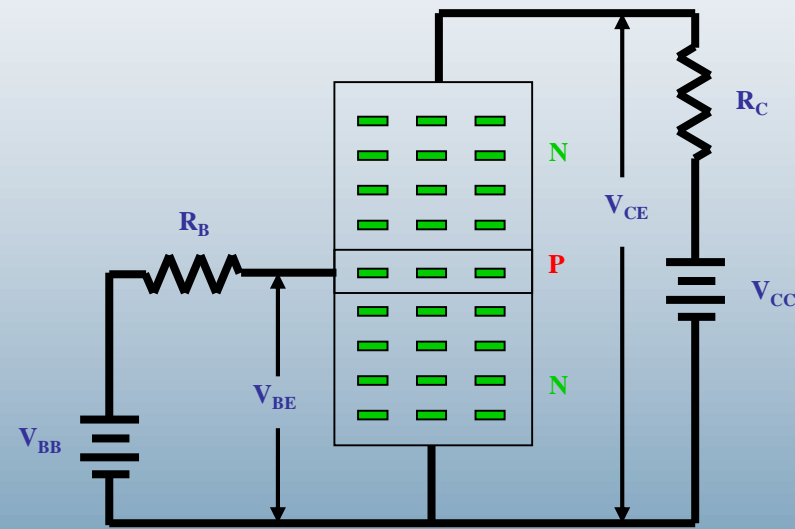
# Which way the free electrons in the base region go?

- **Most continue on to the collector**
  - **Why?**
    - The base is *lightly doped* and *very thin*
    - The light doping means that the free electrons have a long lifetime in the base region
    - The very thin base means that the free electrons have only a short distance to go to reach the collector
    - The positive voltage (reverse voltage) applied to the collector pulls them towards the collector
    - For these reasons, almost all the emitter-injected electrons pass through the base to the collector.
  - **Only a few free electrons will recombine with holes in the lightly doped base**
    - As valence electrons, they flow through the base resistor to the positive side of the  $V_{BB}$  supply



# Summary of Carrier Flow in a Biased NPN Transistor

- $V_{BB}$  forward biases the emitter diode
  - Forces the free electrons in the emitter to enter the base
- The thin and lightly doped base gives almost all these electrons enough time to diffuse into the collector
- These electrons flow through the collector, through  $R_C$  and into the positive terminal of the  $V_{CC}$  voltage source

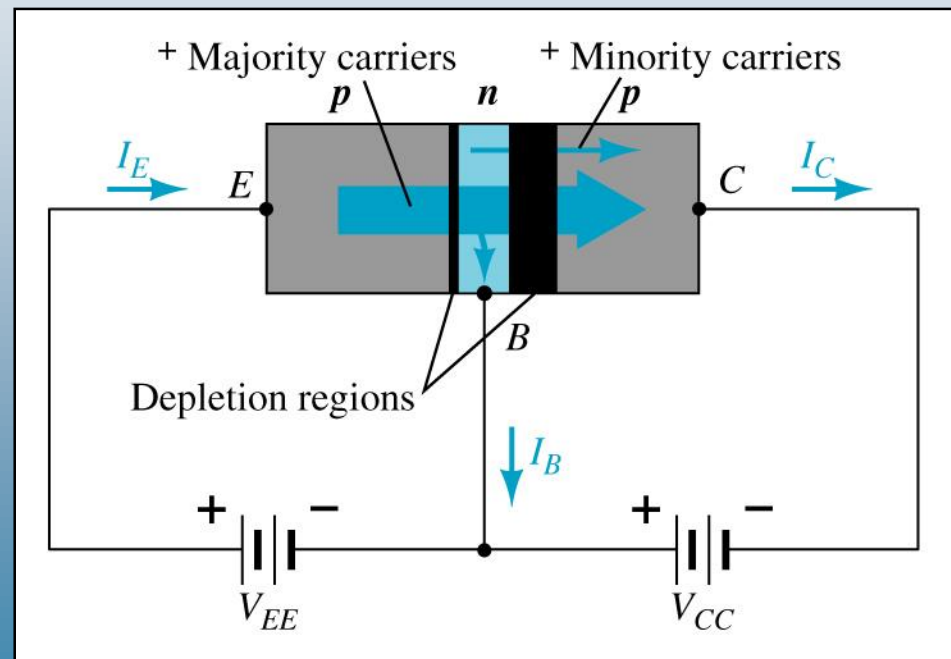


# Transistor Operation

With the external sources,  $V_{EE}$  and  $V_{CC}$ , connected as shown:

The emitter-base junction is forward biased

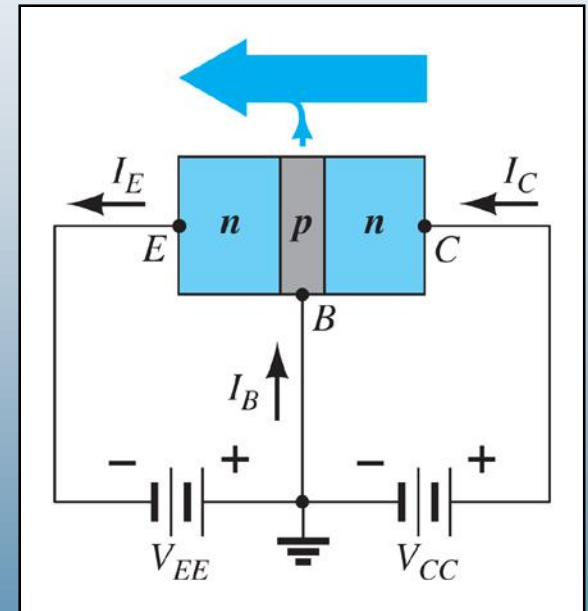
The base-collector junction is reverse biased



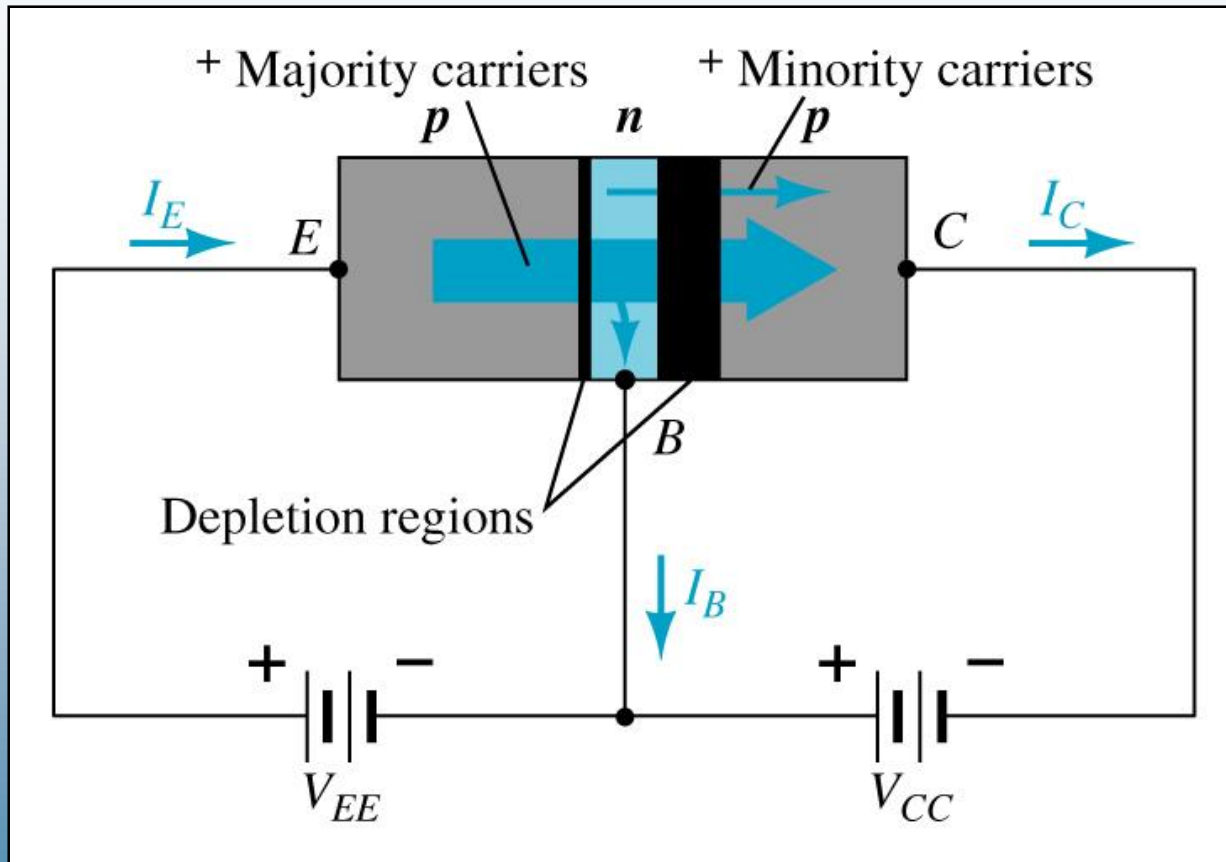
# Currents in a Transistor

Emitter current is the sum of the collector and base currents:

$$I_E = I_C + I_B$$



# Carrier flow in a pnp transistor



Emitter current is the sum of the collector and base currents:

$$I_E = I_C + I_B$$

The collector current is comprised of two currents:

$$I_C = I_{C(\text{majority})} + I_{CO(\text{minority})}$$

# Transistor Connections

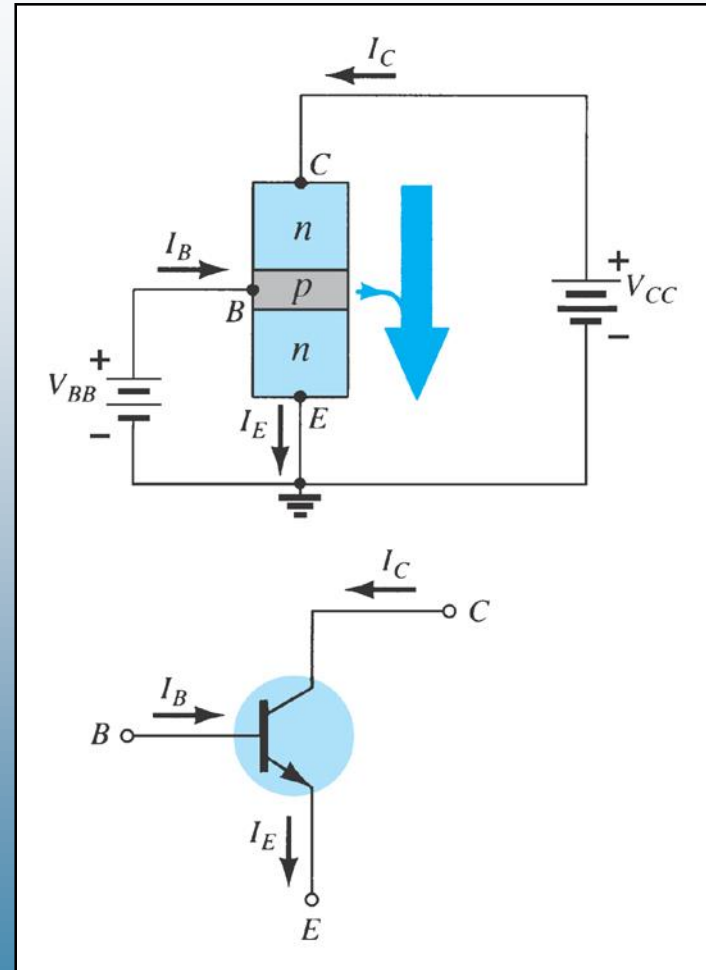
**There are three useful way to connect a transistor:**

- **CE (common emitter) – most widely used**
- **CC (common collector)**
- **CB (common base)**

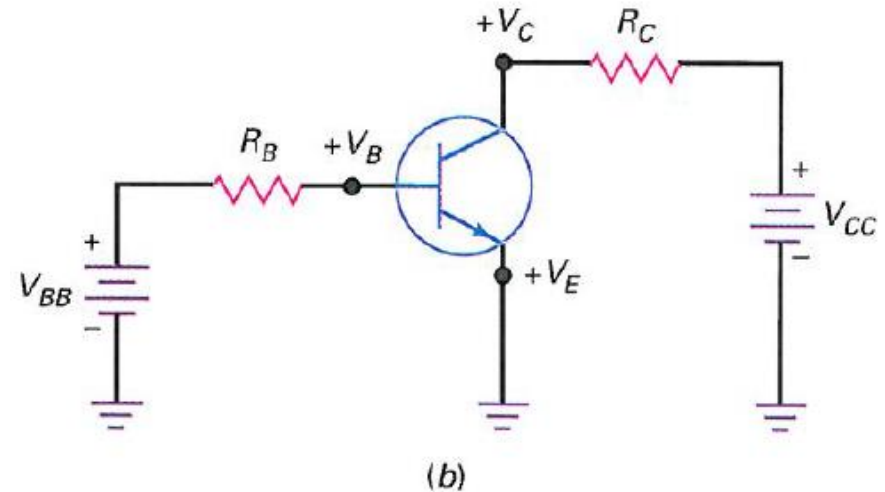
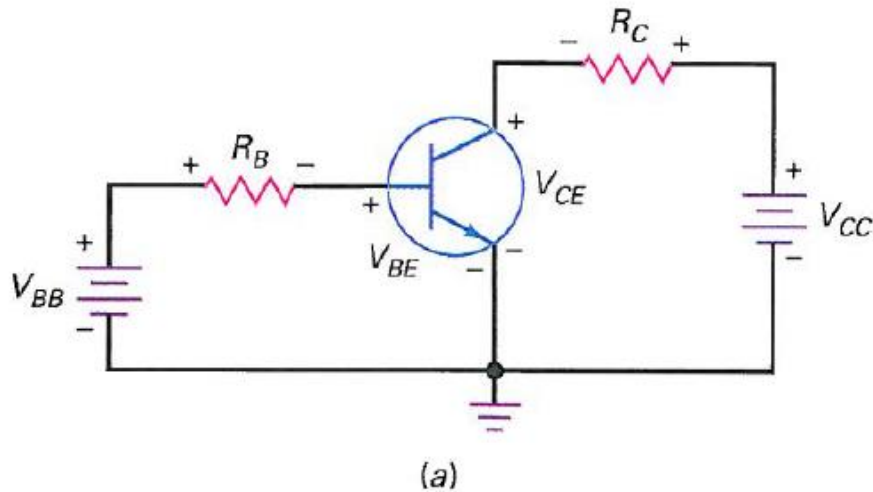
# Common-Emitter Configuration

The emitter is common to both input (base-emitter) and output (collector-emitter) circuits.

The input is applied to the base and the output is taken from the collector.



# The CE connection



$$V_{CE} = V_C - V_E$$

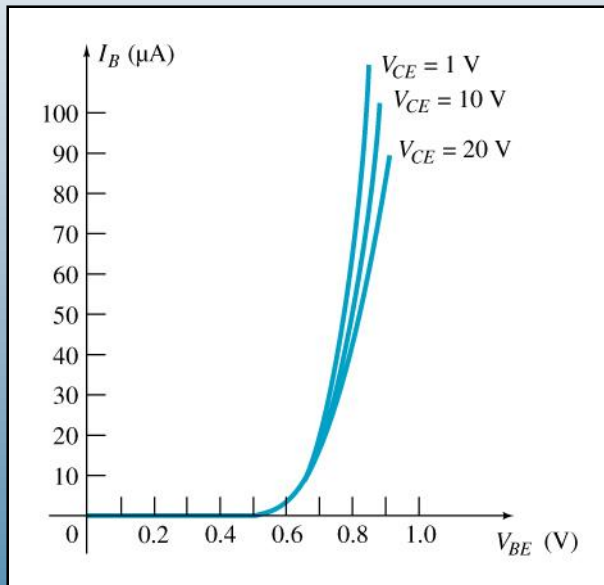
$$V_{CB} = V_C - V_B$$

$$V_{BE} = V_B - V_E$$

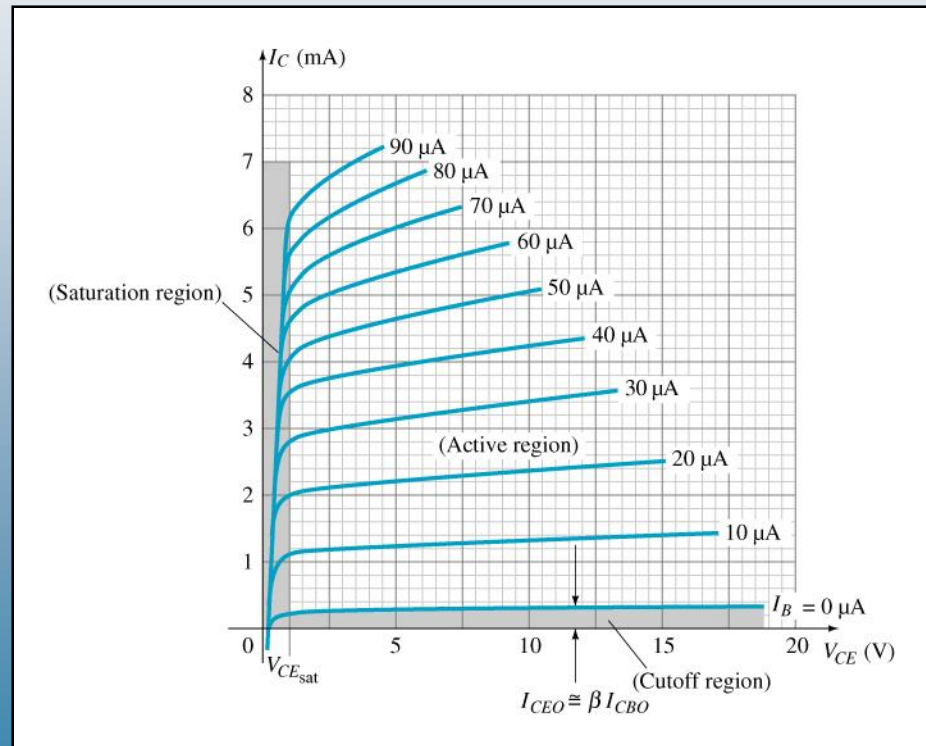
- The emitter is **grounded** or **common**
- The base-emitter acts like a **diode**
- The base-collector acts like a dependent **current source** equal to  $\beta_{dc} I_B$

# CE Transistor Characteristics

- To fully describe the behavior of a BJT, two sets of characteristics are required:
  - Driving point or input characteristics
  - Output side or output characteristics



**Base or Input  
Characteristics**



**Collector or Output  
Characteristics**



# Common-Emitter Amplifier Currents

## Ideal Currents

$$I_E = I_C + I_B \qquad I_C = \alpha I_E$$

## Actual Currents

$$I_C = \alpha I_E + I_{CBO} \quad \text{where } I_{CBO} = \text{minority collector current}$$

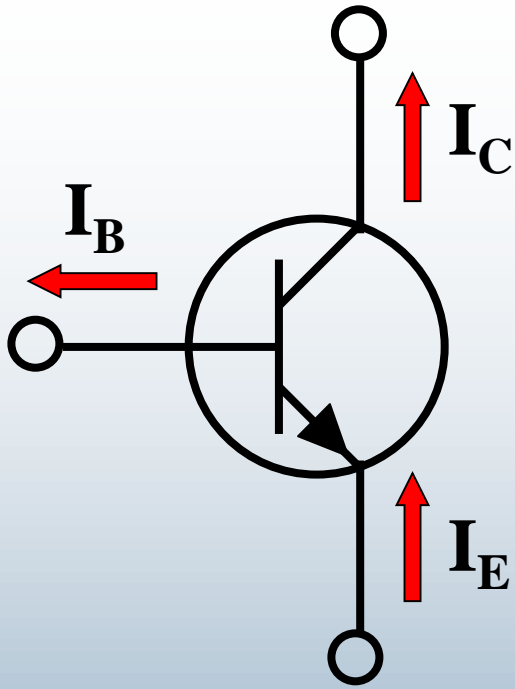
$I_{CBO}$  is usually so small that it can be ignored, except in high power transistors and in high temperature environments.

When  $I_B = 0 \mu\text{A}$  the transistor is in cutoff, but there is some minority current flowing called  $I_{CEO}$ .

$$I_{CEO} = \frac{I_{CBO}}{1 - \alpha} \Big|_{I_B = 0 \mu\text{A}}$$

# Transistor Current Gain

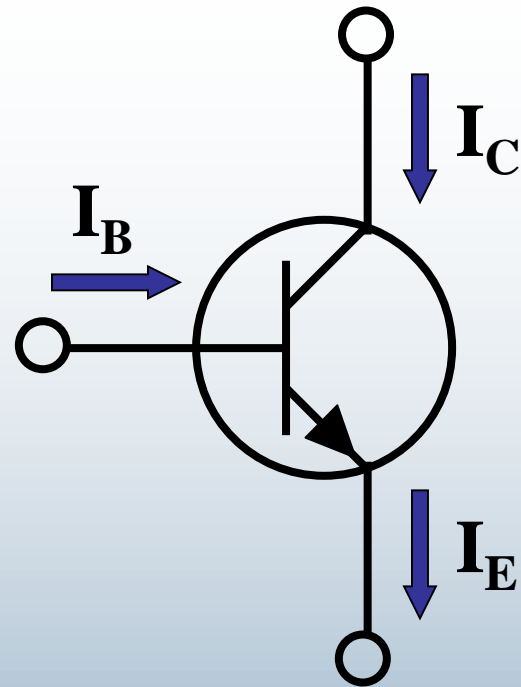
- The ratio of collector current to base current is **current gain** ( $\beta_{dc}$  or  $h_{FE}$ )
- Current gain is typically **100** to **300**



**Electron flow**

$$I_E = I_C + I_B$$

$$\alpha_{dc} = \frac{I_C}{I_E}$$



**Conventional flow**

$$I_C \approx I_E$$

$$I_B \ll I_C$$

$$\beta_{dc} = \frac{I_C}{I_B}$$

# Beta ( $\beta$ )

$\beta$  represents the amplification factor of a transistor.

*In DC mode:*

$$\beta_{dc} = \frac{I_C}{I_B}$$

*In AC mode:*

$$\beta_{ac} = \left. \frac{\Delta I_C}{\Delta I_B} \right|_{V_{CE} = \text{constant}}$$

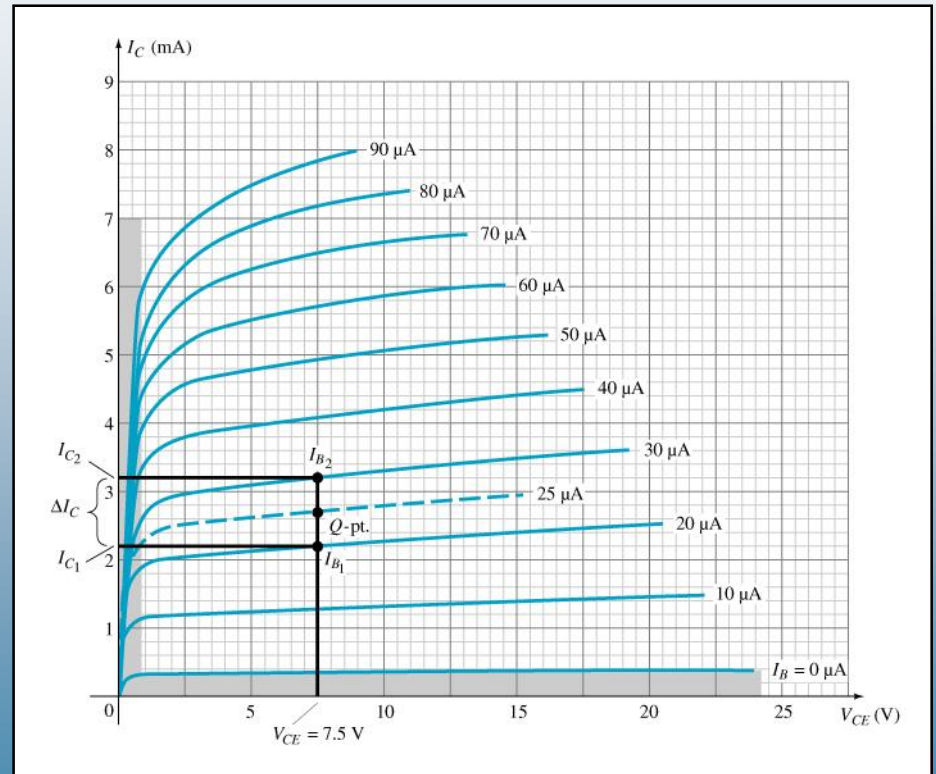
$\beta_{ac}$  is sometimes referred to as  $h_{fe}$ , a term used in transistor modeling calculations

# Beta ( $\beta$ )

## Determining $\beta$ from a Graph

$$\begin{aligned}\beta_{AC} &= \frac{(3.2 \text{ mA} - 2.2 \text{ mA})}{(30 \mu\text{A} - 20 \mu\text{A})} \\ &= \frac{1 \text{ mA}}{10 \mu\text{A}} \Big|_{V_{CE}=7.5 \text{ V}} \\ &= 100\end{aligned}$$

$$\begin{aligned}\beta_{DC} &= \frac{2.7 \text{ mA}}{25 \mu\text{A}} \Big|_{V_{CE}=7.5 \text{ V}} \\ &= 108\end{aligned}$$



## Example 6-1

A transistor has a collector current of 10 mA and a base current of 40  $\mu$ A. What is the current gain of the transistor?

**SOLUTION** Divide the collector current by the base current to get:

$$\beta_{dc} = \frac{10 \text{ mA}}{40 \text{ } \mu\text{A}} = 250$$

## Example 6-2

A transistor has a current gain of 175. If the base current is 0.1 mA, what is the collector current?

**SOLUTION** Multiply the current gain by the base current to get:

$$I_C = 175(0.1 \text{ mA}) = 17.5 \text{ mA}$$

## Example 6-3

A transistor has a collector current of 2 mA. If the current gain is 135, what is the base current?

**SOLUTION** Divide the collector current by the current gain to get:

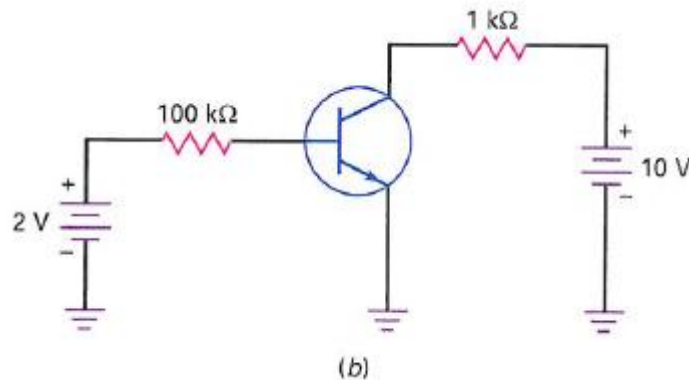
$$I_B = \frac{2 \text{ mA}}{135} = 14.8 \mu\text{A}$$



## Example 6-4



Use the second approximation to calculate the base current in Fig. 6-8b. What is the voltage across the base resistor? The collector current if  $\beta_{dc} = 200$ ?

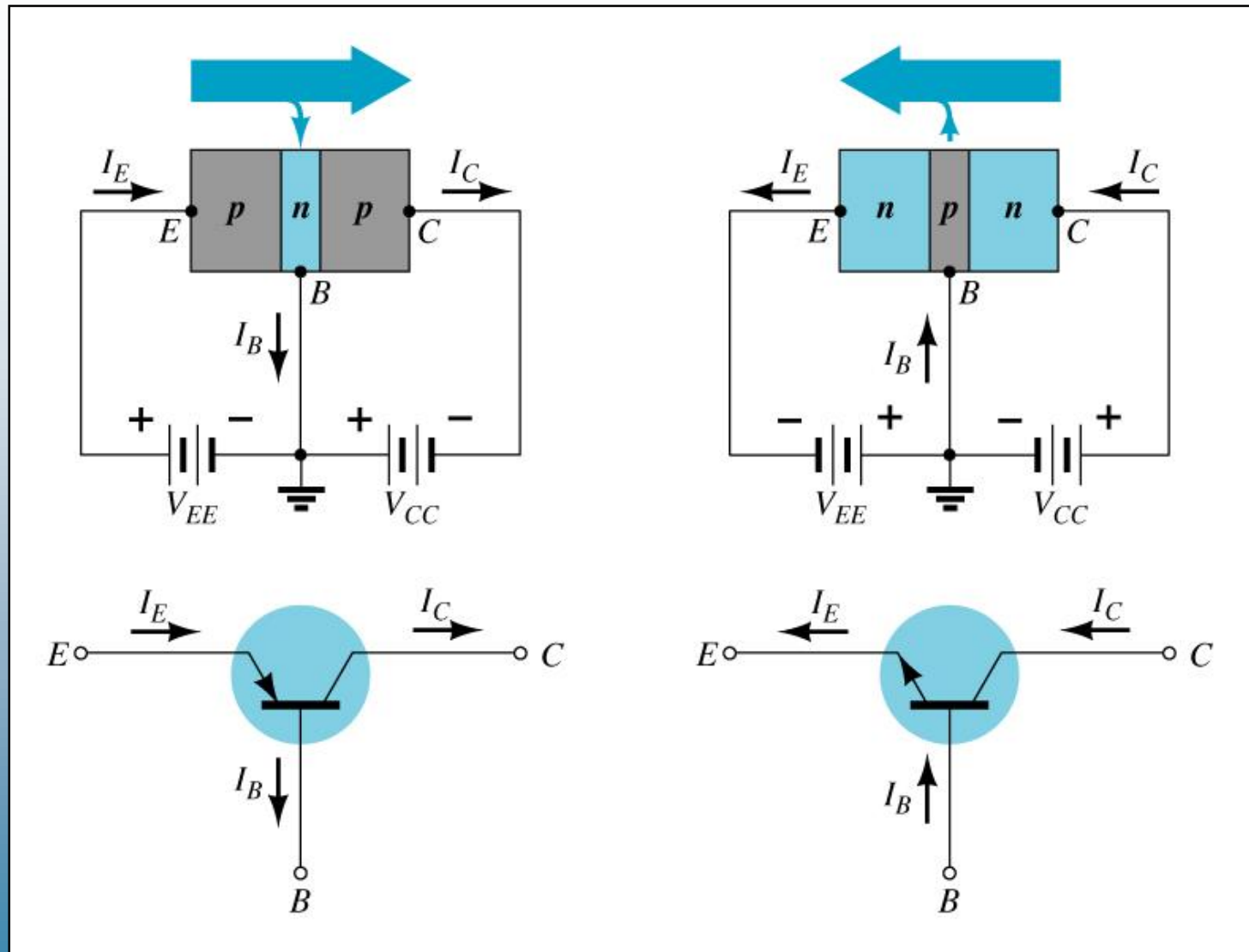


$$V_{BB} - V_{BE} = 2\text{ V} - 0.7\text{ V} = 1.3\text{ V}$$

$$I_B = \frac{V_{BB} - V_{BE}}{R_B} = \frac{1.3\text{ V}}{100\text{ k}\Omega} = 13\text{ }\mu\text{A}$$

$$I_C = \beta_{dc} I_B = (200)(13\text{ }\mu\text{A}) = 2.6\text{ mA}$$

# Common-Base Configuration



The base is common to both input (emitter–base) junction and output (collector–base) junction of the transistor.

# Operating Regions

## Active

Operating range of the amplifier.

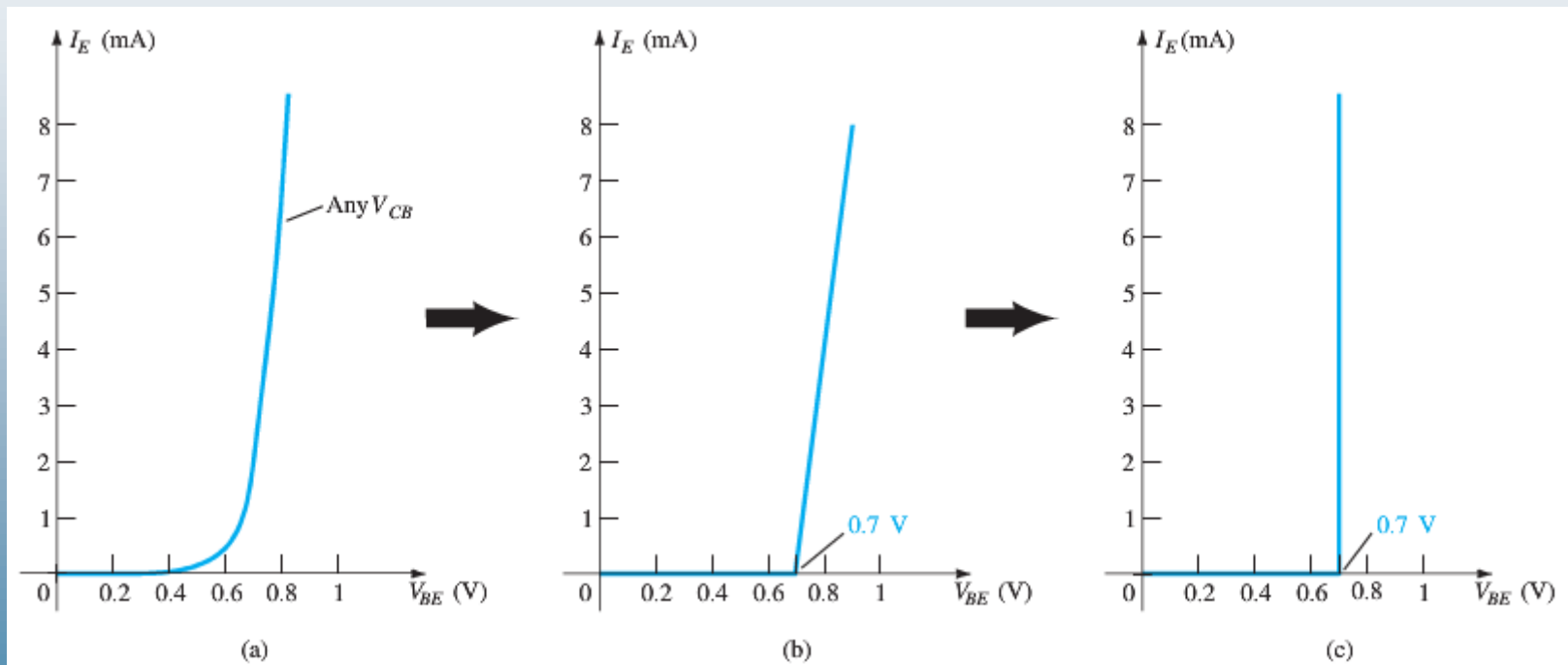
## Cutoff

The amplifier is basically off. There is voltage, but little current.

## Saturation

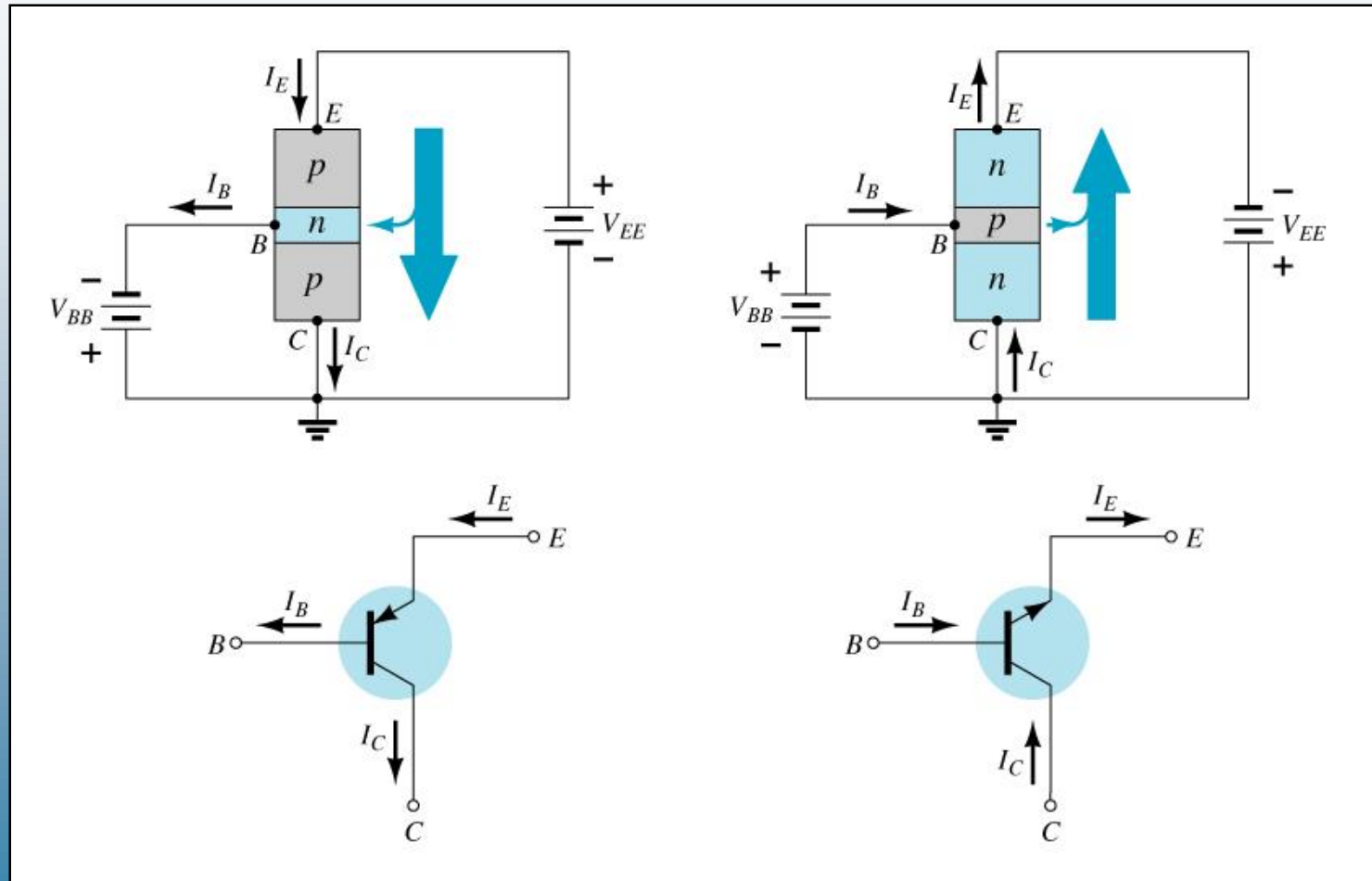
The amplifier is fully on. There is current, but little voltage.

# Developing the equivalent model for the base-to-emitter region



# Common-Collector Configuration

The input is on the base and the output is on the emitter.



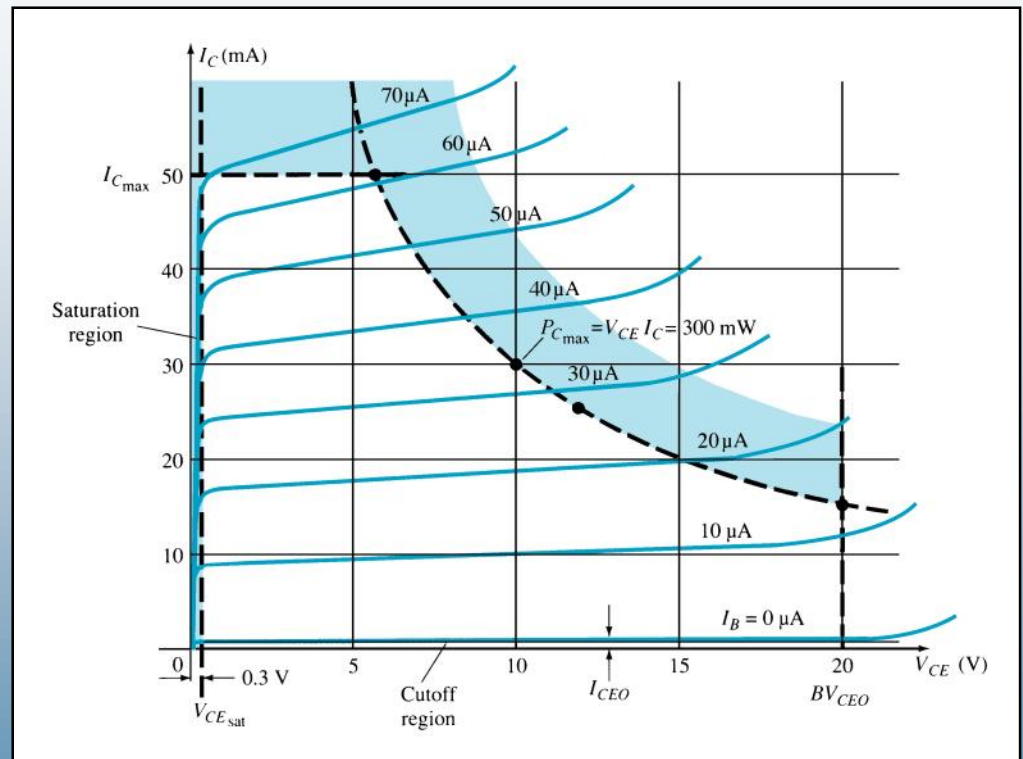
# Operating Limits

$V_{CE}$  is maximum and  $I_C$  is minimum in the cutoff region.

$$I_{C(\max)} = I_{CEO}$$

$I_C$  is maximum and  $V_{CE}$  is minimum in the saturation region.

$$V_{CE(\max)} = V_{CE(sat)} = V_{CEO}$$



The transistor operates in the active region between saturation and cutoff.

# Power Dissipation

Common-base:

$$P_{Cmax} = V_{CB} I_C$$

Common-emitter:

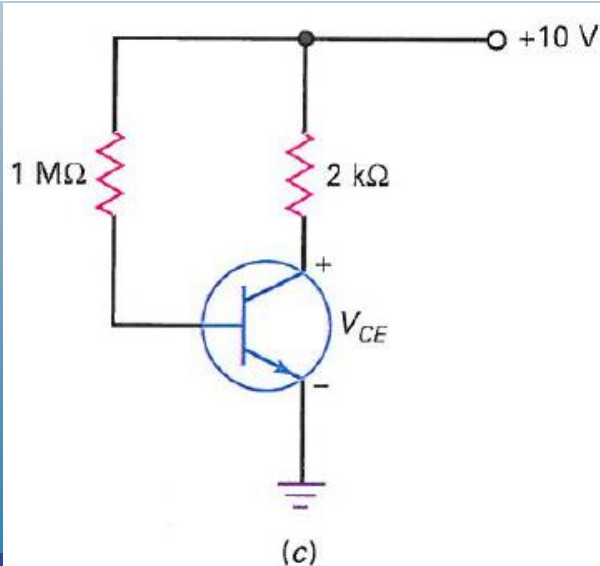
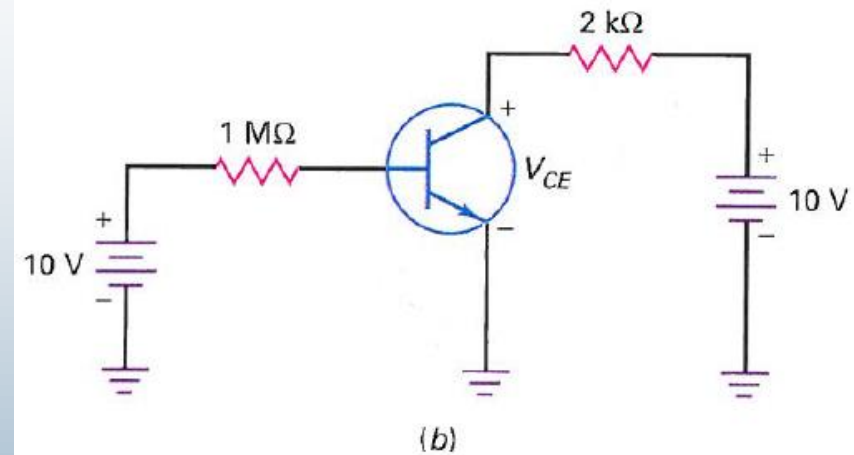
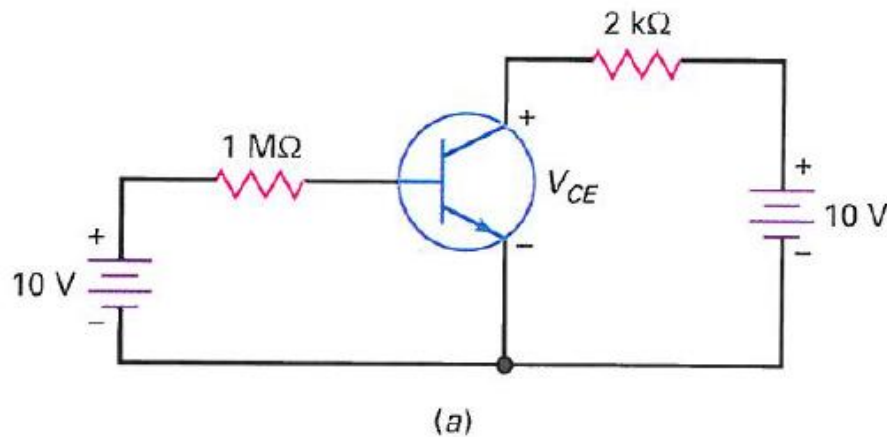
$$P_{Cmax} = V_{CE} I_C$$

Common-collector:

$$P_{Cmax} = V_{CE} I_E$$

## Example 6-5

The transistor of Fig. 6-11a has  $\beta_{dc} = 300$ . Calculate  $I_B$ ,  $I_C$ ,  $V_{CE}$ , and  $P_D$ .



$$I_B = \frac{V_{BB} - V_{BE}}{R_B} = \frac{10 \text{ V} - 0.7 \text{ V}}{1 \text{ M}\Omega} = 9.3 \mu\text{A}$$

$$I_C = \beta_{dc} I_B = (300)(9.3 \mu\text{A}) = 2.79 \text{ mA}$$

$$V_{CE} = V_{CC} - I_C R_C = 10 \text{ V} - (2.79 \text{ mA})(2 \text{ k}\Omega) = 4.42 \text{ V}$$

$$P_D = V_{CE} I_C = (4.42 \text{ V})(2.79 \text{ mA}) = 12.3 \text{ mW}$$



# Transistor Specification Sheet

## MAXIMUM RATINGS

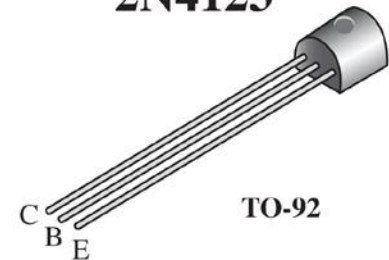
Rating	Symbol	2N4123	Unit
Collector-Emitter Voltage	$V_{CEO}$	30	Vdc
Collector-Base Voltage	$V_{CBO}$	40	Vdc
Emitter-Base Voltage	$V_{EBO}$	5.0	Vdc
Collector Current – Continuous	$I_C$	200	mAdc
Total Device Dissipation @ $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	625 5.0	mW mW/°C
Operating and Storage Junction Temperature Range	$T_j, T_{stg}$	-55 to +150	°C

## THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	83.3	°C W
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	200	°C W

**FAIRCHILD**  
SEMICONDUCTOR <sup>TM</sup>

**2N4123**



TO-92

**General Purpose  
Transistor  
NPN Silicon**

# Transistor Specification Sheet

## ELECTRICAL CHARACTERISTICS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
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### OFF CHARACTERISTICS

Collector-Emitter Breakdown Voltage (1) ( $I_C = 1.0 \text{ mAdc}$ , $I_E = 0$ )	$V_{(BR)CEO}$	30		Vdc
Collector-Base Breakdown Voltage ( $I_C = 10 \text{ }\mu\text{Adc}$ , $I_E = 0$ )	$V_{(BR)CBO}$	40		Vdc
Emitter-Base Breakdown Voltage ( $I_E = 10 \text{ }\mu\text{Adc}$ , $I_C = 0$ )	$V_{(BR)EBO}$	5.0	–	Vdc
Collector Cutoff Current ( $V_{CB} = 20 \text{ Vdc}$ , $I_E = 0$ )	$I_{CBO}$	–	50	nAdc
Emitter Cutoff Current ( $V_{BE} = 3.0 \text{ Vdc}$ , $I_C = 0$ )	$I_{EBO}$	–	50	nAdc

### ON CHARACTERISTICS

DC Current Gain(1) ( $I_C = 2.0 \text{ mAdc}$ , $V_{CE} = 1.0 \text{ Vdc}$ ) ( $I_C = 50 \text{ mAdc}$ , $V_{CE} = 1.0 \text{ Vdc}$ )	$h_{FE}$	50 25	150 –	–
Collector-Emitter Saturation Voltage(1) ( $I_C = 50 \text{ mAdc}$ , $I_B = 5.0 \text{ mAdc}$ )	$V_{CE(sat)}$	–	0.3	Vdc
Base-Emitter Saturation Voltage(1) ( $I_C = 50 \text{ mAdc}$ , $I_B = 5.0 \text{ mAdc}$ )	$V_{BE(sat)}$	–	0.95	Vdc

# Transistor Specification Sheet

## SMALL-SIGNAL CHARACTERISTICS

Current-Gain – Bandwidth Product ( $I_C = 10 \text{ mAdc}$ , $V_{CE} = 20 \text{ Vdc}$ , $f = 100 \text{ MHz}$ )	$f_T$	250		MHz
Output Capacitance ( $V_{CB} = 5.0 \text{ Vdc}$ , $I_E = 0$ , $f = 100 \text{ MHz}$ )	$C_{obo}$	–	4.0	pF
Input Capacitance ( $V_{BE} = 0.5 \text{ Vdc}$ , $I_C = 0$ , $f = 100 \text{ kHz}$ )	$C_{ibo}$	–	8.0	pF
Collector-Base Capacitance ( $I_E = 0$ , $V_{CB} = 5.0 \text{ V}$ , $f = 100 \text{ kHz}$ )	$C_{cb}$	–	4.0	pF
Small-Signal Current Gain ( $I_C = 2.0 \text{ mAdc}$ , $V_{CE} = 10 \text{ Vdc}$ , $f = 1.0 \text{ kHz}$ )	$h_{fe}$	50	200	–
Current Gain – High Frequency ( $I_C = 10 \text{ mAdc}$ , $V_{CE} = 20 \text{ Vdc}$ , $f = 100 \text{ MHz}$ ) ( $I_C = 2.0 \text{ mAdc}$ , $V_{CE} = 10 \text{ V}$ , $f = 1.0 \text{ kHz}$ )	$h_{fe}$	2.5 50	– 200	–
Noise Figure ( $I_C = 100 \text{ } \mu\text{Adc}$ , $V_{CE} = 5.0 \text{ Vdc}$ , $R_S = 1.0 \text{ k ohm}$ , $f = 1.0 \text{ kHz}$ )	NF	–	6.0	dB

(1) Pulse Test: Pulse Width = 300  $\mu\text{s}$ . Duty Cycle = 2.0%